Texas Instruments

Bill of Materials

TI DESIGNS

TIDA-00617

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number
1	1	FB1	500	Bead, Ferrite, 2000mA, 60m-ohm	Steward	MI1206L501R-10
2	1	FB2	500	Bead, Ferrite, 2000mA, 60m-ohm	Steward	MI1206L501R-10
3	1	FB3	500	Bead, Ferrite, 2000mA, 60m-ohm	Steward	MI1206L501R-10
4	1	FB4	500	Bead, Ferrite, 2000mA, 60m-ohm	Steward	MI1206L501R-10
5	1	C2	0.01uF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
6	1	C3	0.01uF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
7	1	C4	0.01uF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
8	1	C5	0.01uF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
9	1	C11	0.01uF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
10	1	C37	0.01uF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
11	1	C36	0.022uF	Capacitor, Ceramic, 50V, X7R, 10%	STD	STD
12	1	C32	0.47uF	Capacitor, Ceramic, 16V, X7R, 10%	STD	STD
13	1	C33	0.47uF	Capacitor, Ceramic, 16V, X7R, 10%	STD	STD
14	1	C34	0.47uF	Capacitor, Ceramic, 16V, X7R, 10%	STD	STD
15	1	C6	1000pF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
16	1	C8	1000pF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number
17	1	C28	1000pF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
18	1	C25	1uF	Capacitor, Ceramic, 16V, X7R, 10%	STD	STD
19	1	C29	1uF	Capacitor, Ceramic, 25V, X7R, 10%	STD	STD
20	1	C38	1uF	Capacitor, Ceramic, 16V, X7R, 10%	STD	STD
21	1	C31	330pF	Capacitor, Ceramic, 50V, C0G, 10%	STD	STD
22	1	C35	DNP	Capacitor, Ceramic, 50V, X7R, 10%	STD	STD
23	1	C7	0.1uF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
24	1	C9	0.1uF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
25	1	C15	0.1uF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
26	1	C19	0.1uF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
27	1	C1	1000pF	Capacitor, Ceramic, 2kV, X7R, 15%	STD	STD
28	1	C10	1000pF	Capacitor, Ceramic, 2kV, X7R, 15%	STD	STD
29	1	C17	1uF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
30	1	C18	1uF	Capacitor, Ceramic, 100V, X7R, 10%	STD	STD
31	1	C20	47uF	Capacitor, Ceramic, 10V, X5R, 15%	STD	STD
32	1	C21	47uF	Capacitor, Ceramic, 10V, X5R, 15%	STD	STD
33	1	C22	47uF	Capacitor, Ceramic, 10V, X5R, 15%	STD	STD
34	1	C26	2200pF	Capacitor, Ceramic, 2KV, X7R, 15%	STD	STD
35	1	C27	22uF	Capacitor, Aluminum, 25V, 20%	Panasonic	EEE-FK1E220R
36	1	C23	330uF	Capacitor, Aluminum, 6.3V, 20%	Panasonic	EEE-FK0J331XP
37	1	C24	330uF	Capacitor, Aluminum, 6.3V, 20%	Panasonic	EEE-FK0J331XP

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number
38	1	C16	47uF	Capacitor, Aluminum, 63V, ±20%	Panasonic	EEE-FK1J470P
39	1	J1	520252	Connector, Jack, Modular, 8 POS	AMP	5520252-4
40	1	J2	520252	Connector, Jack, Modular, 8 POS	AMP	5520252-4
41	1	D15	1N4148W	Diode, Signal, 300-mA, 75-V, 350-mW	Diodes	1N4148W-7-F
42	1	D18	BAT54S	Diode, Dual Schottky, 200mA, 30V	On Semi	BAT54SWT1G
43	1	D19	BAT54S	Diode, Dual Schottky, 200mA, 30V	On Semi	BAT54SWT1G
44	1	D16	MBR0530	Diode, Schottky, 0.5A, 30V	On Semi	MBR0530T1G
45	1	D13	MURS120T3G	Diode, UltraFast Rectifier, 1-A, 200-V	On Semi	MURS120T3G
46	1	D1	B2100	Diode, Schottky, 2-A, 100-V	Diodes	B2100-13-F
47	1	D2	B2100	Diode, Schottky, 2-A, 100-V	Diodes	B2100-13-F
48	1	D3	B2100	Diode, Schottky, 2-A, 100-V	Diodes	B2100-13-F
49	1	D4	B2100	Diode, Schottky, 2-A, 100-V	Diodes	B2100-13-F
50	1	D5	B2100	Diode, Schottky, 2-A, 100-V	Diodes	B2100-13-F
51	1	D7	B2100	Diode, Schottky, 2-A, 100-V	Diodes	B2100-13-F
52	1	D8	B2100	Diode, Schottky, 2-A, 100-V	Diodes	B2100-13-F
53	1	D9	B2100	Diode, Schottky, 2-A, 100-V	Diodes	B2100-13-F
54	1	D10	B2100	Diode, Schottky, 2-A, 100-V	Diodes	B2100-13-F
55	1	D6	SMAJ58A	Diode, TVS, 58-V, 1W	Diodes	SMAJ58A-13-F
56	1	J9	PEC02SAAN	Header, Male 2-pin, 100mil spacing	Sullins	PEC02SAAN
57	1	L1	3.3uH	Inductor, SMT, 1.9A, 80 milliohm	Coilcraft	LPS4018-332ML
58	1	L2	0.33uH	Inductor, SMT, 19.2A, 3.52 milliohm	Coilcraft	XAL5030-331ME

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number
59	1	U4	PC357N4J000F	Photocoupler, 300-600% CTR, 3.75KV Isolation	Sharp	PC357N4J000F
60	1	U7	TCMT1107	IC, Photocoupler, 3750VRMS, 80-160% CTR	Vishay	TCMT1107
61	1	R29	10K	Resistor, Chip, 1/16W, 1%	STD	STD
62	1	R33	10K	Resistor, Chip, 1/16W, 1%	STD	STD
63	1	R37	10K	Resistor, Chip, 1/16W, 1%	STD	STD
64	1	R48	10K	Resistor, Chip, 1/16W, 1%	STD	STD
65	1	R51	13.7K	Resistor, Chip, 1/16W, 1%	STD	STD
66	1	R19	15K	Resistor, Chip, 1/16W, 1%	STD	STD
67	1	R44	1K	Resistor, Chip, 1/16W, 1%	STD	STD
68	1	R21	24.9K	Resistor, Chip, 1/16W, 1%	STD	STD
69	1	R45	3.65K	Resistor, Chip, 1/16W, 1%	STD	STD
70	1	R36	332	Resistor, Chip, 1/16W, 1%	STD	STD
71	1	R49	41.2K	Resistor, Chip, 1/16W, 1%	STD	STD
72	1	R32	43.2	Resistor, Chip, 1/16W, 1%	STD	STD
73	1	R38	43.2	Resistor, Chip, 1/16W, 1%	STD	STD
74	1	R46	49.9	Resistor, Chip, 1/16W, 1%	STD	STD
75	1	R47	604	Resistor, Chip, 1/16W, 1%	STD	STD
76	1	R24	750K	Resistor, Chip, 1/16W, 1%	STD	STD
77	1	R26	63.4	Resistor, Chip, 1/10W, 1%	STD	STD
78	1	R22	39K	Resistor, Chip, 1/4W, 5%	STD	STD
79	1	R34	0.09	Resistor, Chip, 1/2W, 1%	STD	STD

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number
80	1	R30	10	Resistor, Chip, 1W, 5%	STD	
81	1	R5	100K	Resistor, Chip, 1/16W, 1%	STD	STD
82	1	R23	24.9K	Resistor, Chip, 1/16W, 1%	STD	STD
83	1	R28	34K	Resistor, Chip, 1/16W, 1%	STD	STD
84	1	R1	75	Resistor, Chip, 1/16W, 1%	STD	STD
85	1	R2	75	Resistor, Chip, 1/16W, 1%	STD	STD
86	1	R3	75	Resistor, Chip, 1/16W, 1%	STD	STD
87	1	R4	75	Resistor, Chip, 1/16W, 1%	STD	STD
88	1	R6	75	Resistor, Chip, 1/16W, 1%	STD	STD
89	1	R7	75	Resistor, Chip, 1/16W, 1%	STD	STD
90	1	R8	75	Resistor, Chip, 1/16W, 1%	STD	STD
91	1	R9	75	Resistor, Chip, 1/16W, 1%	STD	STD
92	1	R10	8.87K	Resistor, Chip, 1/16W, 1%	STD	STD
93	1	R25	10	Resistor, Chip, 1/10W, 5%	STD	STD
94	1	J3	ED555/2DS	Terminal Block, 2-pin, 6-A, 3.5mm	OST	ED555/2DS
95	1	J10	ED555/2DS	Terminal Block, 2-pin, 6-A, 3.5mm	OST	ED555/2DS
96	1	U8	TLV431A	IC, Shunt Regulator, 6V, 10mA, 1%	TI	TLV431ACDBVR
97	1	TP1	5010	Test Point, Red, Thru Hole	Keystone	5010
98	1	TP3	5010	Test Point, Red, Thru Hole	Keystone	5010
99	1	TP2	5013	Test Point, Orange, Thru Hole	Keystone	5013
100	1	TP4	5013	Test Point, Orange, Thru Hole	Keystone	5013

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number
101	1	TP10	5013	Test Point, Orange, Thru Hole	Keystone	5013
102	1	TP15	5013	Test Point, Orange, Thru Hole	Keystone	5013
103	1	TP16	5013	Test Point, Orange, Thru Hole	Keystone	5013
104	1	U1	TPS23751PWP	IC. IEEE 802.3 AT PoE Interface &	TI	TPS23751PWP
105	1	TP7	5016	Test Point, SM, 0.150 x 0.090	Keystone	5016
106	1	Q4	MMBT2907A	Trans, PNP, 40V, 200mA, 225mW	On Semi	MMBT2907ALT1G
107	1	Q6	MMBT3906	Trans. PNP. 40V. 200mA. 225m-W	On Semi	MMBT3906LT1G
108	1	Q5	BSC520N15NS3G	MOSFET, NChannel, 150V	Infineon	BSC520N15NS3G
109	1	Q3	CSD18504	MOSFET. NChan. 40V. 40A. 6.6 m	Vishay	SIR422DP-T1-GE3
110	1	T1	749022011	Transformer. PoE Plus Gigabit Trai	Wurth Electronics	749022011
111	1	T3	LTC0266-50	XFMR, SMT Gate Drive	LinkCom	LTC0266-50
112	1	T2	LDT0666-50	Transformer. SMT For PoE/PD. 25	LinkCom	LDT0666-50

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